# VS-HFA220FA120

### **Vishay Semiconductors**



HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 220 A



PRIMARY CHARACTERISTICS					
V <sub>R</sub>	1200 V				
V <sub>F</sub> (typical)	2.68 V				
t <sub>rr</sub> (typical)	58 ns				
$I_{F(AV)}$ per module at $T_C$	220 A at 38 °C				
Package	SOT-227				

### FEATURES

- Fast recovery time characteristic
- Electrically isolated base plate
- Large creepage distance between terminal
- · Simplified mechanical designs, rapid assembly
- Designed and qualified for industrial level
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **DESCRIPTION / APPLICATIONS**

The dual diode series configuration (VS-HFA220FA120) is used for output rectification or freewheeling/clamping operation and high voltage application.

The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built.

These modules are intended for general applications such as HV power supplies, electronic welders, motor control and inverters.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Cathode to anode voltage	V <sub>R</sub>		1200	V			
Continuous forward current <sup>(1)</sup>	١ <sub>F</sub>	$T_{\rm C} = 68 \ ^{\circ}{\rm C}$	110	٨			
Single pulse forward current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	700	A			
	Р	T <sub>C</sub> = 25 °C	500	w			
Maximum power dissipation per leg	PD	T <sub>C</sub> = 100 °C	400				
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 minute	2500	V			
Operating junction and storage temperature range	TJ, T <sub>Stg</sub>		-55 to +150	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA	1200	-	-		
Forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 100 A	-	2.68	3.60	V	
		I <sub>F</sub> = 200 A	-	3.41	4.70		
		I <sub>F</sub> = 100 A, T <sub>J</sub> = 150 °C	-	2.62	2.89		
		I <sub>F</sub> = 200 A, T <sub>J</sub> = 150 °C	-	3.59	3.89		
		$V_{R} = V_{R}$ rated	-	10	75	μA	
Reverse leakage current	I <sub>RM</sub>	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	2	-	m۸	
		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	6	15	mA	

#### Note

<sup>(1)</sup> Maximum continuous forward current must be limited at 100 A to do not exceed the maximum temperature of power terminals.

 Revision: 11-Jan-18
 1
 Document Number: 93636

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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = -200 \text{ A}/\mu\text{s}; V_R = 30 \text{ V}$		-	58	-	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	$J_{J} = 125 \degree C$ $J_{J} = 25 \degree C$ $J_{F} = 50 \text{ A}$ $dI_{F} = 50 \text{ A}$	-	157	-	ns
		T <sub>J</sub> = 125 °C		-	255	-	
Peak recovery current	I <sub>RRM</sub> —	T <sub>J</sub> = 25 °C		-	15	-	•
Feak recovery current		T <sub>J</sub> = 125 °C		-	22.5	-	A
Reverse recovery charge	T <sub>1</sub> = 25 °C	T <sub>J</sub> = 25 °C		-	1150	-	nC
neverse recovery charge Q <sub>rr</sub>			-	2850	-	nc	
Junction capacitance	CT	V <sub>R</sub> = 1200 V		-	53	-	pF

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Junction to case, single leg conducting	Р		-	-	0.25		
Junction to case, both legs conducting	- R <sub>thJC</sub>		-	-	0.125	°C/W	
Case to heatsink	R <sub>thCS</sub>	Flat, greased surface	-	0.10	-		
Weight			-	30	-	g	
Mounting torque		Torque to terminal	-	-	1.1 (9.7)	Nm (lbf.in)	
Mounting torque		Torque to heatsink	-	-	1.8 (15.9)	Nm (lbf.in)	
Case style				ç	SOT-227		

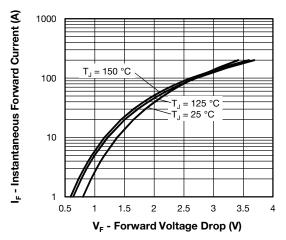


Fig. 1 - Typical Forward Voltage Drop Characteristics (Per Leg)

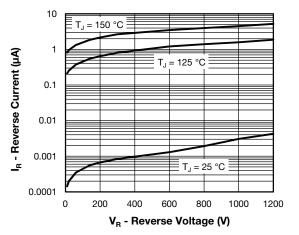


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

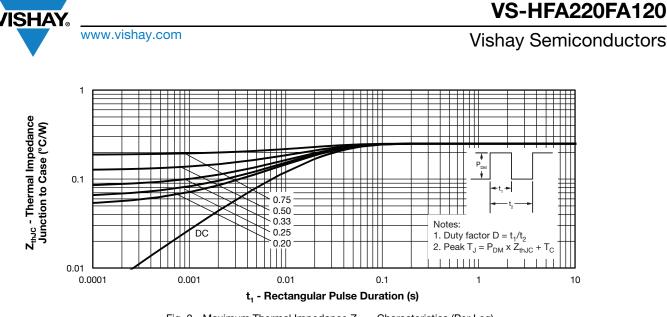


Fig. 3 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)

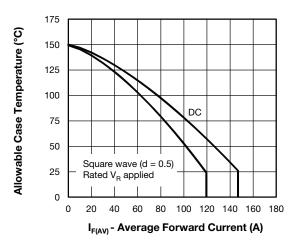


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

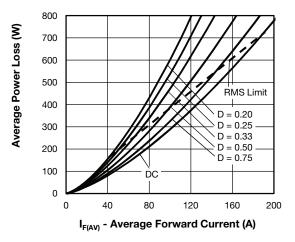


Fig. 5 - Forward Power Losses Characteristics (Per Leg)

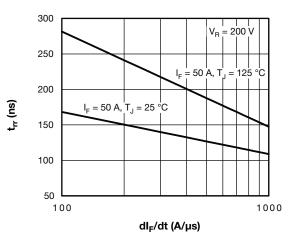
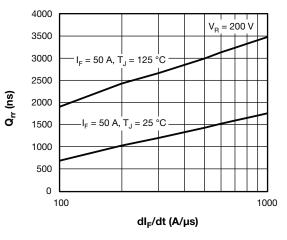


Fig. 6 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt





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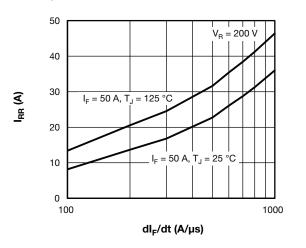
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Fig. 8 - Typical Peak Recovery Current vs. dl<sub>F</sub>/dt

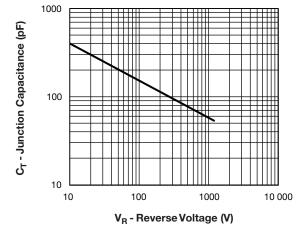


Fig. 9 - Typical Junction Capacitance vs. Reverse Voltage

#### Note

SHA

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC};$   $Pd = Forward power loss = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 5)};$   $Pd_{REV} = Inverse power loss = V_{R1} \times I_R (1 - D); I_R \text{ at } V_{R1} = Rated V_R$ 

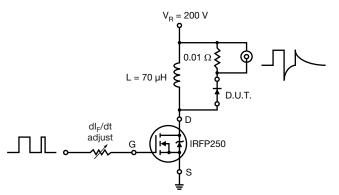


Fig. 10 - Reverse Recovery Parameter Test Circuit

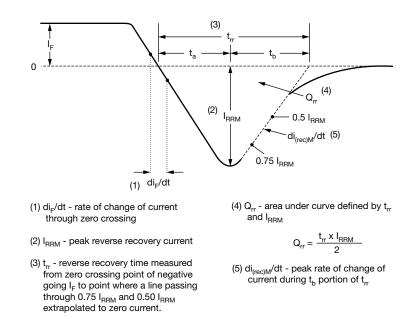


Fig. 11 - Reverse Recovery Waveform and Definitions

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### **ORDERING INFORMATION TABLE**

Device code	VS-	HF	A	220	F	A	120
	1	2	3	4	5	6	7
	1 -	Visł	nay Sem	niconduc	tors pro	oduct	
	2 -	HEX	HEXFRED <sup>®</sup> family				
	3 -	Pro	Process designator (A = electron irradiated)				
	4 -	Ave	rage cu	rrent (22	20 = 220	) A)	
	5 -	Circ	cuit conf	iguratior	n (two se	eparate	diodes
	6 -	Pac	kage in	dicator (	SOT-22	27 stand	lard ins
	7 -	Volt	tage rati	ng (120	= 1200	V)	

CIRCUIT CONFIGURATION						
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING				
Two separate diodes, parallel pin-out	F	Lead Assignment				

LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?95423						
Packaging information	www.vishay.com/doc?95425					



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